

Electronic Acknowledgement Receipt

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Title of Invention:	Sealant Epoxy-Resin Molding Material, and Electronic Component Device
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement Letter	08-07-18_IDS_with_cert.pdf	69947 5c94901b7a496b654cb6f30c4f6838f14f5696c7	no	3

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2	Information Disclosure Statement (IDS) Filed	08-07-18_US_IDS_Form__S B_08a.pdf	660336 11ccb7005f43a9d817ffd4109549d480 1c03f4d	no	4
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3	Foreign Reference	08-07-18_FR01_CN_163698 7.pdf	65381 939be9a7c34b7b098f252c1a68d83984 09fcedaa	no	2
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4	NPL Documents	08-07-18_NPL01_Office_Act ion.pdf	660221 2a343d7732dff132ea0d0cf686702b77a 12deebb	no	17
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